

# Power Transistor

Transistors are building blocks of electronic appliances, and can be found in radios, computers, and calculators, to name a few. When working with electrical systems you typically have to deal with heat transfer; electric heating is often an unwanted result of current conduction.

This example simulates a system consisting of a small part of a circuit board containing a power transistor and the copper pathways connected to the transistor. The purpose of the simulation is to estimate the operating temperature of the transistor, which can be substantially higher than room temperature due to undesired electric heating.

Transistors are semiconductor devices used to switch or amplify electronic signals. There are different types of transistors, ranging in size depending on how they are packaged. Power transistors carry and dissipate more power and therefore come in larger packages. These packages can be attached to a heat sink for better cooling and to avoid overheating of the system.

The heat sink would then be attached to the transistor via the copper plate located behind the ceramic piece (shown in Figure 1 to the left). While it's often important to construct a way to cool electronic systems, such as in the case of components in hybrid cars, each system has its own acceptable operating temperature range. What determines the maximum and minimum temperature limits include the semiconductor material properties, the transistor type, the design of the device, and so forth. There is a conventional temperature range, however, which is thought to be between -55°C and 125°C.

# Model Definition

Figure 1 shows the model geometry used in the simulation. The power transistor is mounted on the circuit board using through-hole technology. The solder in the holes give mechanical support and electronic contact between the copper routes and the transistor pins.

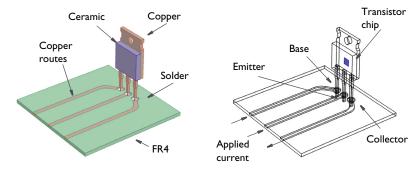


Figure 1: Model geometry and position of transistor chip.

The transistor chip itself is a very thin structure represented by an internal surface in Figure 1. The chip is connected to the pins but these connections are assumed to have negligible effects on heat transfer.

The transistor package front part is made of ceramics while the back part, which could be clamped to a heat sink, is made of copper. The transistor chip and the front part of the package have matching thermal properties. The copper pins are soldered to the circuit board by the solder material 60Sn-40Pb (60% tin and 40% lead). The circuit board is made of FR4.

Current conduction and Joule heating take place in the copper routes, in the solders, and in the pins. In these parts, the physics of heat transfer and heat production due to Joule heating are fully coupled to the conduction of electric current. In all other parts of the transistor, only heat transfer and heat production take place.

The transistor chip itself is represented by an interior boundary with an internal production of heat corresponding to 0.9 W. Cooling through convection takes place at all external boundaries with a heat transfer coefficient of 5.0 W/(m<sup>2</sup>·K). This value of the heat transfer coefficient corresponds to the worst case scenario when the fan is switched off. The ambient temperature is 293.15 K.

Current enters the circuit board at the left vertical boundaries of the copper routes connected to the base, emitter, and collector in Figure 1. The value of the current at the boundary of the route connected to the emitter is 0.2 A. The value of the current at the boundary of the route connected to the collector is 0.1998 A. The difference in absolute current between the emitter and collector currents corresponds to the current at the boundary of the route connected to the base, which is 0.2 mA.

## Results and Discussion

Figure 2 below shows the temperature distribution in the device. The maximum temperature is about 354 K or 81°C. This is well within the acceptable operation temperature range for the transistor, which implies that attaching it to a heat sink is not needed in this case.

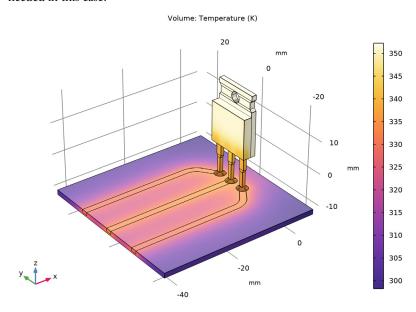


Figure 2: Temperature distribution.

Also worth noting is that electric heating, or Joule heating as it is also referred to, hardly influences the temperature of the copper routes at the distance from the transistor modeled above. That's most likely due to copper's high conductivity; some of the heat produced in the transistor chip is conducted away from the device via the copper routes. Figure 3 shows the temperature along the copper routes connected to the base and the collector respectively. The current density in the base is 1/1000 of that in the collector but the temperature in the copper routes connected to the base and collector is almost identical.

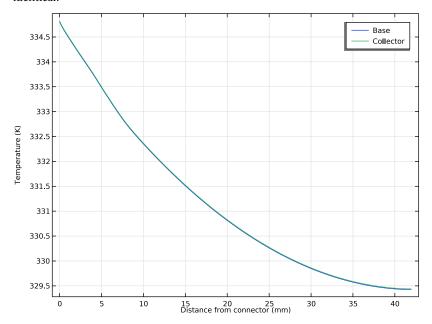


Figure 3: Temperature along the copper routes connected to the base and collector.

The fact that the Joule heating effect does not increase temperature in the copper routes leads to the conclusion that the higher temperature in these routes is due to coppers high conductivity. The copper routes conduct some of the heat produced in the transistor chip away from this device. The circuit board has a poor thermal conductivity and is therefore not heated to the same extent as the copper routes.

# Notes About the COMSOL Implementation

You can find all the material properties for this application in COMSOL's Material Library. Furthermore, the ready-made physics interface for Joule heating sets up all model formulations that you need for the simulation: Electric Current and Heat Transfer in Solids are added with the corresponding Joule Heating coupling features in the Multiphysics node.

The Joule heating interface is by default available for all materials in the model. However, the circuit board material and the package material do no conduct electric current. For this reason, you have to edit the selection of Electric current physics to remove nonconducting domains. On the circuit board material, only heat transfer physics is calculated. By removing the nonconductive parts of the device to the list of Electric Current physics, Electromagnetic Heat Source and Boundary Electromagnetic Heat Source are automatically not applicable on these domains.

Application Library path: Heat\_Transfer\_Module/

Power Electronics and Electronic Cooling/power transistor

## Modeling Instructions

From the File menu, choose New.

#### NEW

In the New window, click Model Wizard.

#### MODEL WIZARD

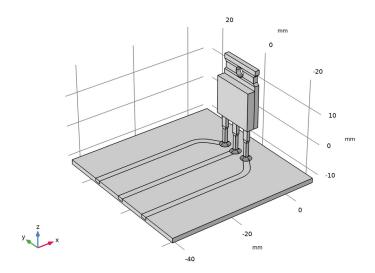
- I In the Model Wizard window, click **3D**.
- 2 In the Select Physics tree, select Heat Transfer>Electromagnetic Heating>Joule Heating.
- 3 Click Add.
- 4 Click 🔵 Study.
- 5 In the Select Study tree, select General Studies>Stationary.
- 6 Click M Done.

#### **GEOMETRY I**

The geometry sequence for the model is available in a file. If you want to create it from scratch yourself, you can follow the instructions in the Geometry Modeling Instructions section. Otherwise, insert the geometry sequence as follows:

- I In the Geometry toolbar, click Insert Sequence and choose Insert Sequence.
- 2 Browse to the model's Application Libraries folder and double-click the file power\_transistor\_geom\_sequence.mph.
- 3 In the Geometry toolbar, click **Build All**.
- 4 Click the **Zoom Extents** button in the **Graphics** toolbar.

5 In the Model Builder window, under Component I (compl) click Geometry I.



You should now see the geometry shown above.

#### **GLOBAL DEFINITIONS**

## Parameters 1

- I In the Model Builder window, under Global Definitions click Parameters I.
- 2 In the Settings window for Parameters, locate the Parameters section.
- **3** In the table, enter the following settings:

Name	Expression	Value	Description
j_CE	1e5[A/m^2]	IE5 A/m²	Current density, collector and emitter routes
Q_h	1e5[W/m^2]	IE5 W/m²	Boundary heat source strength
h_coeff	5[W/(m^2*K)]	5 W/(m <sup>2</sup> ·K)	Heat transfer coefficient

#### ADD MATERIAL

- I In the Home toolbar, click **Add Material** to open the Add Material window.
- 2 Go to the Add Material window.
- 3 In the tree, select Built-in>Copper.
- 4 Click Add to Component in the window toolbar.

- 5 In the tree, select Built-in>FR4 (Circuit Board).
- **6** Click **Add to Component** in the window toolbar.
- 7 In the tree, select Built-in>Silica glass.
- **8** Click **Add to Component** in the window toolbar.
- 9 In the tree, select Built-in>Solder, 60Sn-40Pb.
- 10 Click Add to Component in the window toolbar.
- II In the Home toolbar, click 4 Add Material to close the Add Material window.

#### MATERIALS

Cobber (mat I)

- I Click the Wireframe Rendering button in the Graphics toolbar.
- 2 In the Model Builder window, under Component I (compl)>Materials click Copper (matl).
- 3 In the Settings window for Material, locate the Geometric Entity Selection section.
- 4 Click Clear Selection.
- **5** Select Domains 2–4 and 9–12 only.

FR4 (Circuit Board) (mat2)

- I In the Model Builder window, click FR4 (Circuit Board) (mat2).
- 2 Select Domain 1 only.

Silica glass (mat3)

- I In the Model Builder window, click Silica glass (mat3).
- 2 Select Domain 8 only.

Solder, 60Sn-40Pb (mat4)

- I In the Model Builder window, click Solder, 60Sn-40Pb (mat4).
- **2** Select Domains 5–7 only.
- 3 In the Settings window for Material, locate the Material Contents section.
- **4** In the table, enter the following settings:

Property	Variable	Value	Unit	Property group
Relative permittivity	epsilonr_iso; epsilonrii = epsilonr_iso, epsilonrij = 0	1	I	Basic

#### **ELECTRIC CURRENTS (EC)**

- I In the Model Builder window, under Component I (compl) click Electric Currents (ec).
- **2** Select Domains 2–7 and 9–11 only.

#### Ground I

- I In the Physics toolbar, click **Boundaries** and choose **Ground**.
- 2 Select Boundaries 84, 104, and 124 only.

## Normal Current Density I

- I In the Physics toolbar, click **Boundaries** and choose Normal Current Density.
- 2 Select Boundary 10 only.
- 3 In the Settings window for Normal Current Density, locate the Normal Current Density section.
- **4** In the  $J_n$  text field, type  $(1-1e-3)*j_CE$ .

## Normal Current Density 2

- I In the Physics toolbar, click **Boundaries** and choose Normal Current Density.
- 2 Select Boundary 5 only.
- 3 In the Settings window for Normal Current Density, locate the Normal Current Density section.
- **4** In the  $J_n$  text field, type j\_CE.

## Normal Current Density 3

- I In the Physics toolbar, click **Boundaries** and choose Normal Current Density.
- 2 Select Boundary 15 only.
- 3 In the Settings window for Normal Current Density, locate the Normal Current Density section.
- **4** In the  $J_n$  text field, type 1e-3\*j\_CE.

## HEAT TRANSFER IN SOLIDS (HT)

In the Model Builder window, under Component I (compl) click Heat Transfer in Solids (ht).

#### Heat Flux I

- I In the Physics toolbar, click **Boundaries** and choose **Heat Flux**.
- 2 In the Settings window for Heat Flux, locate the Boundary Selection section.
- 3 From the Selection list, choose All boundaries.
- 4 Locate the Heat Flux section. From the Flux type list, choose Convective heat flux.

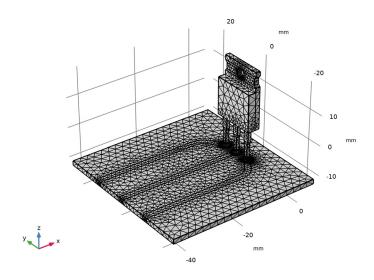
**5** In the *h* text field, type h\_coeff.

## Boundary Heat Source I

- I In the Physics toolbar, click **Boundaries** and choose **Boundary Heat Source**.
- 2 In the Settings window for Boundary Heat Source, locate the Boundary Selection section.
- 3 From the Selection list, choose Transistor Chip.
- **4** Locate the **Boundary Heat Source** section. In the  $Q_{\rm b}$  text field, type  $Q_{\rm c}$ h.

#### MESH I

- I In the Model Builder window, under Component I (compl) click Mesh I.
- 2 In the Settings window for Mesh, locate the Physics-Controlled Mesh section.
- 3 From the Element size list, choose Fine.
- 4 Click III Build All.



## STUDY I

In the **Home** toolbar, click **Compute**.

## RESULTS

Electric Potential (ec)

In the Electric Potential (ec) toolbar, click  **Plot**.

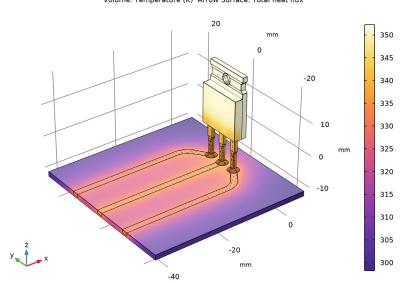
## Temperature (ht)

The third default plot shows the temperature. Add an arrow plot of the total heat flux.

I In the Model Builder window, click Temperature (ht).

## Arrow Surface 1

- I In the Temperature (ht) toolbar, click Arrow Surface.
- 2 In the Settings window for Arrow Surface, click Replace Expression in the upper-right corner of the Expression section. From the menu, choose Component I (compl)> Heat Transfer in Solids>Domain fluxes>ht.tfluxx,...,ht.tfluxz Total heat flux.
- 3 Locate the Arrow Positioning section. In the Number of arrows text field, type 5e3.
- 4 Locate the Coloring and Style section. From the Color list, choose Black.
- 5 In the Temperature (ht) toolbar, click Plot.
- 6 Click the **Q** Zoom In button in the Graphics toolbar.



Volume: Temperature (K) Arrow Surface: Total heat flux

7 Click the **Zoom Extents** button in the **Graphics** toolbar.

Finally, reproduce the plot in Figure 3 by following the steps outlined below.

## Temperature along Copper Routes

I In the Home toolbar, click In Add Plot Group and choose ID Plot Group.

2 In the Settings window for ID Plot Group, type Temperature along Copper Routes in the Label text field.

Line Graph 1

- I In the Temperature along Copper Routes toolbar, click Line Graph.
- **2** Select Edges 28, 41, 50, 59, and 65 only.
- 3 In the Settings window for Line Graph, click Replace Expression in the upper-right corner of the y-Axis Data section. From the menu, choose Component I (compl)> Heat Transfer in Solids>Temperature>T - Temperature - K.
- 4 Locate the x-Axis Data section. From the Parameter list, choose Reversed arc length.
- **5** Click to expand the **Legends** section. Select the **Show legends** check box.
- 6 From the Legends list, choose Manual.
- 7 In the table, enter the following settings:

# Legends Base

- 8 In the Temperature along Copper Routes toolbar, click Plot.
- 9 Right-click Line Graph I and choose Duplicate.

Line Graph 2

- I In the Model Builder window, click Line Graph 2.
- 2 In the Settings window for Line Graph, locate the Selection section.
- **3** Click to select the **Activate Selection** toggle button.
- 4 Select Edges 14, 38, 47, 56, and 62 only.
- **5** Locate the **Legends** section. In the table, enter the following settings:

# Legends Collector

6 In the Temperature along Copper Routes toolbar, click **Temperature** Plot.

Temperature along Copper Routes

- I In the Model Builder window, click Temperature along Copper Routes.
- 2 In the Settings window for ID Plot Group, click to expand the Title section.
- **3** From the **Title type** list, choose **None**.
- 4 Locate the Plot Settings section.

- 5 Select the x-axis label check box. In the associated text field, type Distance from connector (mm).
- 6 In the Temperature along Copper Routes toolbar, click  **Plot**.

## Geometry Modeling Instructions

If you want to create the geometry yourself, follow these steps.

#### **GEOMETRY I**

- I In the Model Builder window, under Component I (compl) click Geometry I.
- 2 In the Settings window for Geometry, locate the Units section.
- 3 From the Length unit list, choose mm.

Block I (blk I)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- 3 In the Width text field, type 50.
- 4 In the **Depth** text field, type 50.
- 5 In the Height text field, type 1.5.
- **6** Locate the **Position** section. In the **x** text field, type -44.
- 7 In the y text field, type -25.
- 8 In the z text field, type -12.

Work Plane I (wbl)

- I In the Geometry toolbar, click Work Plane.
- 2 In the Settings window for Work Plane, locate the Plane Definition section.
- 3 In the z-coordinate text field, type -10.5.

Work Plane I (wb I)>Plane Geometry

In the Model Builder window, click Plane Geometry.

Work Plane I (wpl)>Rectangle I (rl)

- I In the Work Plane toolbar, click Rectangle.
- 2 In the Settings window for Rectangle, locate the Size and Shape section.
- 3 In the Width text field, type 34.
- 4 In the Height text field, type 2.
- 5 Locate the Position section. In the xw text field, type -44.

6 In the yw text field, type 10.5.

Work Plane I (wpl)>Circle I (cl)

- I In the Work Plane toolbar, click ( Circle.
- 2 In the Settings window for Circle, locate the Size and Shape section.
- 3 In the Sector angle text field, type 180.
- 4 In the Radius text field, type 6.5.
- **5** Locate the **Position** section. In the **xw** text field, type -10.
- 6 In the yw text field, type 6.
- 7 Locate the Rotation Angle section. In the Rotation text field, type -45.
- 8 Click to expand the **Layers** section. In the table, enter the following settings:

Layer name	Thickness (mm)
Layer 1	2

Work Plane I (wp I)>Circle 2 (c2)

- I In the Work Plane toolbar, click ( Circle.
- 2 In the Settings window for Circle, locate the Size and Shape section.
- 3 In the Radius text field, type 1.75.
- 4 Locate the **Position** section. In the xw text field, type -2.5.
- 5 In the yw text field, type 5.
- **6** Locate the **Layers** section. In the table, enter the following settings:

Layer name	Thickness (mm)
Layer 1	0.85

Work Plane I (wpl)>Tangent I (tanl)

- I In the Work Plane toolbar, click \( \simeg \) Tangent.
- 2 On the object c1, select Boundary 9 only.
- 3 In the Settings window for Tangent, locate the Tangent section.
- 4 Click to select the Activate Selection toggle button for Second edge to tangent.
- 5 On the object c2, select Boundary 11 only.
- 6 In the tree, select c2.

Work Plane I (wpI)>Tangent 2 (tan2)

I In the Work Plane toolbar, click \(^{\infty}\) Tangent.

- **2** On the object **c1**, select Boundary 8 only.
- 3 In the Settings window for Tangent, locate the Tangent section.
- 4 Click to select the Activate Selection toggle button for Second edge to tangent.
- **5** On the object **c2**, select Boundary 7 only.
- **6** In the tree, select **c2**.

Work Plane I (wp I)>Convert to Curve I (ccur I)

- I In the Work Plane toolbar, click Conversions and choose Convert to Curve.
- 2 Click in the **Graphics** window and then press Ctrl+A to select all objects.
- 3 In the Settings window for Convert to Curve, click 📳 Build Selected.

Work Plane I (wp I)>Delete Entities I (del I)

- I In the Work Plane toolbar, click Delete.
- 2 In the Settings window for Delete Entities, locate the Entities or Objects to Delete section.
- 3 From the Geometric entity level list, choose Boundary.
- 4 On the object ccurl, select Boundaries 5, 7, 8, 10, 27, 30, and 32 only.

Work Plane I (wp I)>Convert to Solid I (csoll)

- I In the Work Plane toolbar, click Conversions and choose Convert to Solid.
- 2 Select the object dell only.

Work Plane I (wpl)>Union I (unil)

- I In the Work Plane toolbar, click Booleans and Partitions and choose Union.
- **2** Select the object **csoll** only.
- 3 In the Settings window for Union, locate the Union section.
- 4 Clear the Keep interior boundaries check box.

Plane Geometry

- I In the Model Builder window, collapse the Component I (comp1)>Geometry I> Work Plane I (wp1)>Plane Geometry node.
- 2 In the Model Builder window, click Plane Geometry.

Work Plane I (wb I)>Rectangle 2 (r2)

- I In the Work Plane toolbar, click Rectangle.
- 2 In the Settings window for Rectangle, locate the Size and Shape section.
- 3 In the Width text field, type 40.5.
- 4 In the **Height** text field, type 2.

- **5** Locate the **Position** section. In the **xw** text field, type -44.
- 6 In the yw text field, type -1.

Work Plane I (wb I)>Circle 3 (c3)

- I In the Work Plane toolbar, click Circle.
- 2 In the Settings window for Circle, locate the Size and Shape section.
- 3 In the Radius text field, type 1.75.
- 4 Locate the **Position** section. In the xw text field, type -2.5.

Work Plane I (wb I)>Union 2 (uni2)

- I In the Work Plane toolbar, click Booleans and Partitions and choose Union.
- 2 Select the objects c3 and r2 only.
- 3 In the Settings window for Union, locate the Union section.
- 4 Clear the **Keep interior boundaries** check box.

Work Plane I (wpl)>Mirror I (mirl)

- I In the Work Plane toolbar, click Transforms and choose Mirror.
- 2 Select the object unil only.
- 3 In the Settings window for Mirror, locate the Input section.
- 4 Select the **Keep input objects** check box.
- 5 Locate the Normal Vector to Line of Reflection section. In the xw text field, type 0.
- 6 In the yw text field, type 1.

Extrude I (ext I)

- I In the Model Builder window, under Component I (compl)>Geometry I right-click Work Plane I (wpI) and choose Extrude.
- 2 In the Settings window for Extrude, locate the Distances section.
- 3 Select the Reverse direction check box.

Block 2 (blk2)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- 3 In the Height text field, type 9.
- 4 Locate the **Position** section. In the x text field, type -3.
- **5** In the **y** text field, type 4.5.
- 6 In the z text field, type -14.05.

## Block 3 (blk3)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- 3 In the **Depth** text field, type 1.75.
- 4 In the Height text field, type 6.
- 5 Locate the **Position** section. In the x text field, type -3.
- 6 In the y text field, type 4.125.
- 7 In the z text field, type -4.25.

## Hexahedron I (hex I)

- I In the Geometry toolbar, click  $\bigoplus$  More Primitives and choose Hexahedron.
- 2 In the Settings window for Hexahedron, locate the Vertices section.
- 3 In row 1, set x to -3.
- 4 In row 1, set y to 4.5.
- 5 In row 1, set z to -5.05.
- 6 In row 2, set z to -5.05.
- 7 In row 3, set z to -5.05.
- 8 In row 4, set z to -5.05.
- 9 In row 5, set z to -4.25.
- 10 In row 6, set z to -4.25.
- II In row 7, set z to -4.25.
- 12 In row 8, set z to -4.25.
- **I3** In row **2**, set **y** to **4.5**.
- **14** In row **3**, set **y** to **5.5**.
- **15** In row **4**, set **y** to **5**.5.
- **16** In row **5**, set **y** to **4.125**.
- 17 In row 6, set y to 4.125.
- **18** In row **7**, set **y** to **5**.875.
- **19** In row **8**, set **y** to **5.875**.
- **20** In row **2**, set **x** to -2.
- 21 In row 3, set x to -2.
- **22** In row **4**, set **x** to -3.

- **23** In row **5**, set **x** to -3.
- **24** In row **6**, set **x** to -2.
- **25** In row **7**, set **x** to -2.
- **26** In row **8**, set **x** to -3.

## Union I (uni I)

- I In the Geometry toolbar, click Booleans and Partitions and choose Union.
- 2 Select the objects blk2, blk3, and hex1 only.
- 3 In the Settings window for Union, locate the Union section.
- 4 Clear the Keep interior boundaries check box.

## Block 4 (blk4)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- **3** In the **Width** text field, type **2.5**.
- 4 In the **Depth** text field, type 14.
- 5 In the Height text field, type 12.5.
- 6 Locate the Position section. In the x text field, type -4.
- 7 In the y text field, type -7.

#### Block 5 (blk5)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- 3 In the Width text field, type 1.5.
- 4 In the **Depth** text field, type 14.
- 5 In the Height text field, type 14.
- 6 Locate the **Position** section. In the **x** text field, type -1.5.
- 7 In the y text field, type -7.

#### Block 6 (blk6)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- 3 In the Width text field, type 1.5.
- 4 In the **Depth** text field, type 12.5.
- 5 In the Height text field, type 2.

- 6 Locate the Position section. In the x text field, type -1.5.
- 7 In the y text field, type -6.25.
- 8 In the z text field, type 14.75.

## Block 7 (blk7)

- I In the Geometry toolbar, click Block.
- 2 In the Settings window for Block, locate the Size and Shape section.
- **3** In the **Width** text field, type 1.5.
- 4 In the **Depth** text field, type 14.
- 5 In the Height text field, type 1.5.
- 6 Locate the Position section. In the x text field, type -1.5.
- 7 In the y text field, type -7.
- **8** In the **z** text field, type 17.5.

## Hexahedron 2 (hex2)

- I In the Geometry toolbar, click  $\bigoplus$  More Primitives and choose Hexahedron.
- 2 In the Settings window for Hexahedron, locate the Vertices section.
- 3 In row 1, set x to -1.5.
- 4 In row 1, set y to -7.
- **5** In row **1**, set **z** to **14**.
- 6 In row 2, set y to -7.
- 7 In row 2, set z to 14.
- **8** In row **3**, set **y** to 7.
- 9 In row 3, set z to 14.
- **10** In row **3**, set **x** to **0**.
- II In row 4, set x to -1.5.
- **12** In row **4**, set **y** to 7.
- **I3** In row **4**, set **z** to 14.
- **14** In row **5**, set **x** to -1.5.
- **I5** In row **5**, set **y** to -6.25.
- **16** In row **5**, set **z** to 14.75.
- 17 In row 6, set y to -6.25.
- **18** In row **6**, set **z** to 14.75.

- **19** In row **7**, set **x** to **0**.
- 20 In row 7, set y to 6.25.
- 21 In row 7, set z to 14.75.
- **22** In row **8**, set **x** to -1.5.
- 23 In row 8, set y to 6.25.
- 24 In row 8, set z to 14.75.

## Mirror I (mir I)

- I In the Geometry toolbar, click Transforms and choose Mirror.
- 2 Select the object hex2 only.
- 3 In the Settings window for Mirror, locate the Input section.
- **4** Select the **Keep input objects** check box.
- 5 Locate the Point on Plane of Reflection section. In the z text field, type 15.75.

## Union 2 (uni2)

- I In the Geometry toolbar, click Booleans and Partitions and choose Union.
- 2 Select the objects blk5, blk6, blk7, hex2, and mir1 only.
- 3 In the Settings window for Union, locate the Union section.
- 4 Clear the **Keep interior boundaries** check box.

## Cylinder I (cyl1)

- I In the Geometry toolbar, click Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 1.65.
- 4 In the **Height** text field, type 1.5.
- 5 Locate the **Position** section. In the x text field, type -1.5.
- **6** In the **z** text field, type 15.75.
- 7 Locate the Axis section. From the Axis type list, choose x-axis.

#### Difference I (dif1)

- I In the Geometry toolbar, click Booleans and Partitions and choose Difference.
- 2 Select the object uni2 only.
- 3 In the Settings window for Difference, locate the Difference section.
- 4 Click to select the Activate Selection toggle button for Objects to subtract.
- **5** Select the object **cyll** only.

Transistor Chip

- I In the Geometry toolbar, click Work Plane.
- 2 In the Settings window for Work Plane, type Transistor Chip in the Label text field.
- 3 Locate the Plane Definition section. From the Plane type list, choose Face parallel.
- 4 On the object dif1, select Boundary 1 only.

Transistor Chip (wp2)>Plane Geometry

In the Model Builder window, click Plane Geometry.

Transistor Chip (wp2)>Square I (sq1)

- I In the Work Plane toolbar, click Square.
- 2 In the Settings window for Square, locate the Size section.
- 3 In the Side length text field, type 3.
- 4 Locate the **Position** section. In the xw text field, type -1.5.

Transistor Chip (wp2)

- I In the Model Builder window, under Component I (compl)>Geometry I click Transistor Chip (wp2).
- 2 In the Settings window for Work Plane, locate the Selections of Resulting Entities section.
- **3** Select the **Resulting objects selection** check box.

Work Plane 3 (wb3)

- I In the Geometry toolbar, click Work Plane.
- 2 In the Settings window for Work Plane, locate the Plane Definition section.
- 3 From the Plane list, choose yz-plane.
- 4 In the x-coordinate text field, type -2.5.

Work Plane 3 (wp3)>Plane Geometry

In the Model Builder window, click Plane Geometry.

Work Plane 3 (wp3)>Polygon 1 (pol1)

- I In the Work Plane toolbar, click / Polygon.
- 2 In the Settings window for Polygon, locate the Object Type section.
- **3** From the **Type** list, choose **Open curve**.
- 4 Locate the Coordinates section. From the Data source list, choose Vectors.
- **5** In the **xw** text field, type **5.5 5.5 5.9 5.9 6.75**.
- 6 In the yw text field, type -9.7 -12 -12 -10.5 -10.5.

Work Plane 3 (wp3)>Quadratic Bézier I (qb1)

- I In the Work Plane toolbar, click \* More Primitives and choose Quadratic Bézier.
- 2 In the Settings window for Quadratic Bézier, locate the Control Points section.
- 3 In row 1, set xw to 6.75.
- 4 In row 2, set xw to 5.5.
- **5** In row **3**, set **xw** to **5.5**.
- 6 In row 1, set yw to -10.5.
- 7 In row 2, set yw to -10.3.
- 8 In row 3, set yw to -9.7.
- 9 Locate the Weights section. In the 2 text field, type 0.5/sqrt(2).

Work Plane 3 (wp3)>Convert to Solid 1 (csol1)

- I In the Work Plane toolbar, click Conversions and choose Convert to Solid.
- 2 Click in the **Graphics** window and then press Ctrl+A to select both objects.

Revolve I (rev1)

- I In the Model Builder window, under Component I (compl)>Geometry I right-click Work Plane 3 (wp3) and choose Revolve.
- 2 In the Settings window for Revolve, locate the Revolution Angles section.
- 3 Clear the Keep original faces check box.
- 4 Locate the Revolution Axis section. From the Axis type list, choose 3D.
- 5 Find the Point on the revolution axis subsection. In the x text field, type -2.5.
- 6 In the y text field, type 5.
- 7 In the z text field, type -5.05.
- 8 Find the Direction of revolution axis subsection. In the y text field, type 0.
- 9 In the z text field, type 1.

Union 3 (uni3)

- I In the Geometry toolbar, click Booleans and Partitions and choose Union.
- 2 Select the objects rev1 and uni1 only.

Array I (arr I)

- I In the Geometry toolbar, click Transforms and choose Array.
- 2 Select the object uni3 only.
- 3 In the Settings window for Array, locate the Size section.

- 4 In the y size text field, type 3.
- **5** Locate the **Displacement** section. In the **y** text field, type -5.

Form Composite Domains I (cmd1)

- I In the Geometry toolbar, click "Virtual Operations and choose Form Composite Domains.
- 2 Click the Wireframe Rendering button in the Graphics toolbar.
- 3 On the object fin, select Domain 39 only.
- **4** On the object **fin**, select Domains 15, 16, 26, 27, 30, 37–47, and 60–65 only.
- **5** On the object **fin**, select Domains 11, 12, 15, 16, 26–47, and 54–65 only.
- 6 On the object fin, select Domains 15–65 only.

Form Composite Domains 2 (cmd2)

- I In the Geometry toolbar, click Virtual Operations and choose Form Composite Domains.
- 2 Click the Select Box button in the Graphics toolbar.
- 3 On the object cmd1, select Domains 5–7 and 9–14 only.